SEMICONDUCTOR TECHNICAL DATA

GBJ8A ~ GBJ8M

GLASS PASSIVATED CHIP SINGLE-PHASE BRIDGE RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current 8.0 Amperes

Features

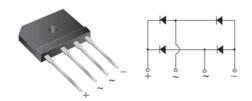
- Glass passivated junction
- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction
- Plastic material has Underwriters Laboratory Flammability Classification 94V-0
- ◆ Surge overload rating to 170 amperes peak
- ◆ High case dielectric strength of 2500V_{RMS}

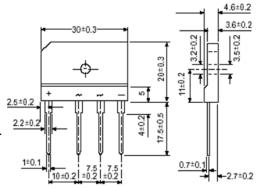
Mechanical Data

- ◆ Case: GBJ(5S)
 - Epoxy meets UL-94V-0 Flammability rating
- ◆ Terminals: Leads solderable per MILSTD-750 Method 2026
- High temperature soldering guaranteed: 260°C/10 seconds, 0.375 (9.5mm) lead length, 5 bs.(2.3kg) tension
- ◆ Weight: 0.24 ounce, 6.8 grams
- ◆ Mounting torque: 8.17 in. lbs. max.

Typical Applications

General purpose use in ac-to-dc bridge full wave rectification for Switching Power Supply, Home Appliances, Office Equipment, Industrial Automation applications





Package outline dimensions in millimeters

Maximum Ratings and Electrical Characteristics

Revision No: 0

Rating at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	GBJ8A	GBJ8B	GBJ8D	GBJ8G	GBJ8J	GBJ8K	GBJ8M	Units
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified output current (See Fig.2)	I _{F(AV)}	8.0							Amps
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	L _{FSM}	180							Amps
Rating for fusing (t<8.3ms)	l²t	120							A²sec
Maximum instantaneous forward voltage drop per leg at 4.0A	V _F	1.0							Volt
Maximum DC reverse current T_{Λ} =25°C at rated DC blocking voltage per leg T_{Λ} =125°C	l _R	5.0 250.0							uА
Typical thermal resistance per leg (Note 2)	R _{euc}	1.6							°C/W
Dielectric strength (Therminals to case, AC 1 minute)	V _{ISO}	2500							Volts
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150							°C

Notes 1. Unit case mounted on AL plate heatsink

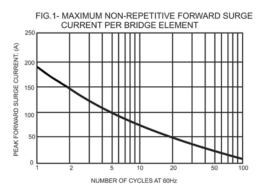
- 2. Unit mounted on P.C B.with 4"x0.06" (100x100x1 6mm) copper pads and 0.375" (9 5mm) lead length
- 3. Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw

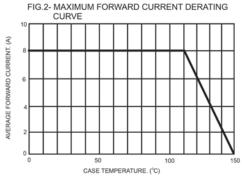


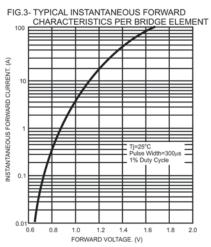


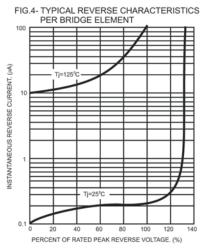
RATINGS AND CHARACTERISTIC CURVES

(T_A = 25°C unless otherwise noted)









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